



Features

- Hot-pluggable SFP footprint
- Extended case temperature range (0°C to +70°C)
- Fully metallic enclosure for low EMI
- Low power dissipation (1.05 W typical)
- Compact RJ-45 connector assembly
- Compatible with IEEE802.3u
- Access to physical layer IC via 2-wire serial bus
- A 10/100BASE-TX/100BASE-FX converter

XSUExC-MIRN

Copper SFP Transceiver

Applications

- This 100Base-TX Copper SFP Transceiver supports the SFP based switch 100Base-FX ports that accept standard 100Base-FX optics SFP

Description

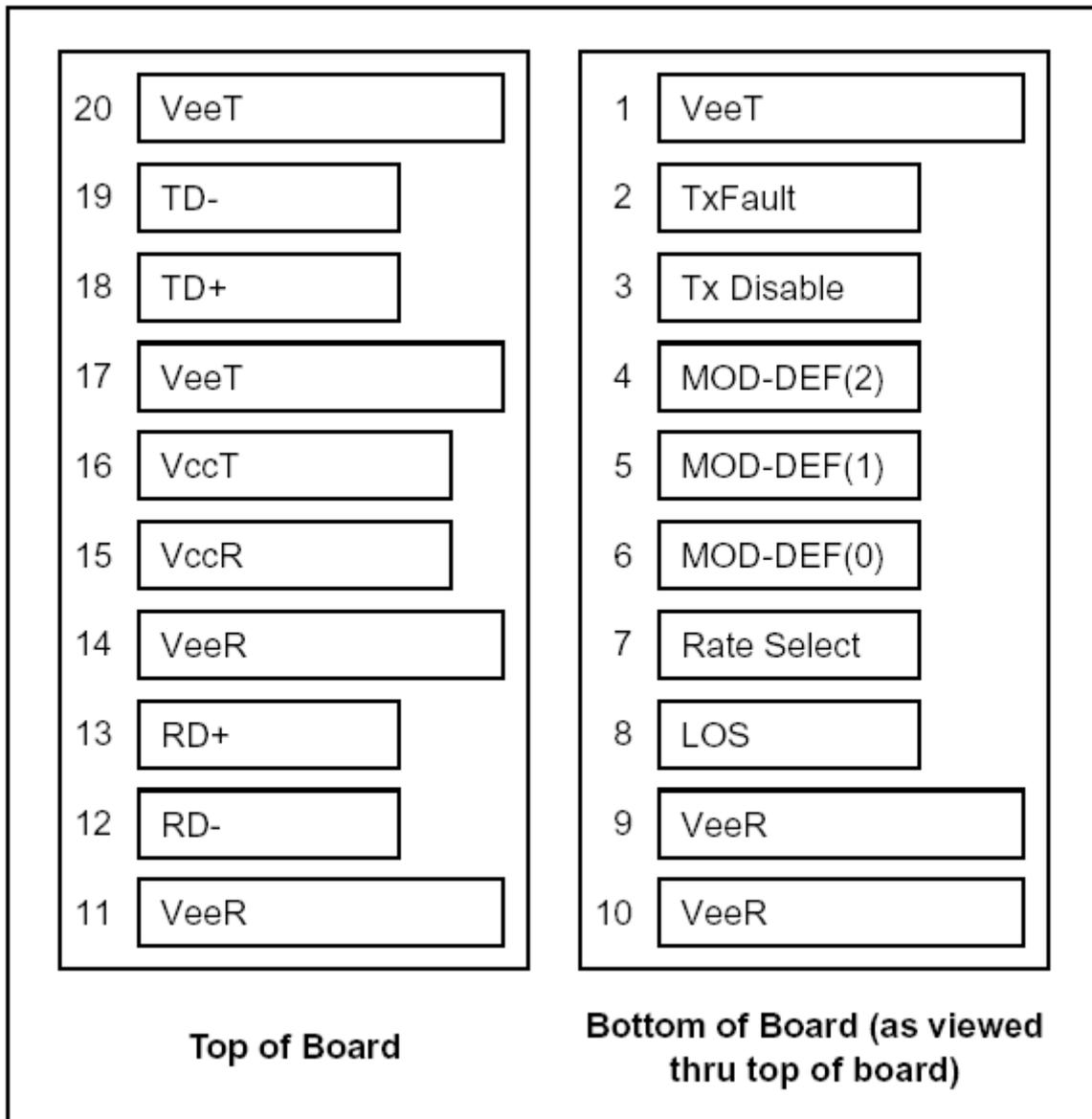
Xenya's XSUExC-MIRN Copper Small Form Pluggable (SFP) transceivers is high performance, The SFP 10/100Base-TX performs a suitable magnetic conversion of the signal from the PHY transceiver (MDI medium dependent interface) to the 10/100Base-TX interface (transporting data over unshielded twisted pair category 5 cable) and vice versa according IEEE 802.3-2002.

The SFP 10/100Base-TX contains a RJ45 connector, magnetics, serial electrical interface and electronics (EEPROM) to carry out all the monitoring (e.g. inventory) data. The SFP 10/100Base-TX meets the Small Form Pluggable (SFP) package utilising an MSA platform, except the module accommodates the RJ45 jack by extending above and below the outside top of the cage.

The monitoring (e.g. inventory) data will be available through a 2-wire serial interface, the encoding requirements are strictly SFP MSA compliant.

Pin Definitions

Pin Diagram



Pin Descriptions

Pin	Signal Name	Description	Plug Seq.	Notes
1	V _{EET}	Transmitter Ground	1	
2	TX FAULT	Transmitter Fault Indication	3	Note 1
3	TX DISABLE	Transmitter Disable	3	Note 2
4	MOD_DEF(2)	SDA Serial Data Signal	3	Note 3
5	MOD_DEF(1)	SCL Serial Clock Signal	3	Note 3
6	MOD_DEF(0)	TTL Low	3	Note 3
7	Rate Select	Not Connected	3	
8	LOS	Loss of Signal	3	Note 4
9	V _{EER}	Receiver ground	1	
10	V _{EER}	Receiver ground	1	
11	V _{EER}	Receiver ground	1	
12	RX-	Inv. Received Data Out	3	Note 5
13	RX+	Received Data Out	3	Note 5
14	V _{EER}	Receiver ground	1	
15	V _{CCR}	Receiver Power Supply	2	
16	V _{CCT}	Transmitter Power Supply	2	
17	V _{EET}	Transmitter Ground	1	
18	TX+	Transmit Data In	3	Note 6
19	TX-	Inv. Transmit Data In	3	Note 6
20	V _{EET}	Transmitter Ground	1	

Notes:

Plug Seq.: Pin engagement sequence during hot plugging.

- 1) TX Fault is not supported and is always connected to ground.
- 2) TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a 4.7 K 10 K resistor. Its states are:
 - Low (0 to 0.8V): Transmitter on
 - (>0.8, < 2.0V): Undefined
 - High (2.0 to 3.465V): Transmitter Disabled
 - Open: Transmitter Disabled
- 3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a 4.7K to 10K resistor on the host board. The pull-up voltage shall be V_{ccT} or V_{ccR}
 - Mod-Def 0 is grounded by the module to indicate that the module is present
 - Mod-Def 1 is the clock line of two wire serial interface for serial ID
 - Mod-Def 2 is the data line of two wire serial interface for serial ID
- 4) LOS: This active high signal is asserted when the status of network is Link Down. RxLOS is active low when the status of network is Linkup.
- 5) RD-/+ : These are the differential receiver outputs. They are AC coupled 100 differential lines which should be terminated with 100 (differential) at the user SERDES.
- 6) TD-/+ : These are the differential transmitter inputs. They are AC-coupled, differential lines with 100 differential termination inside the module.

+3.3V Volt Electrical Power Interface

The XSUExC-MIRN has an input voltage range of +3.3V +/- 5%. The 3.3V maximum voltage is not allowed for continuous operation.

Table 1. +3.3V Volt electrical power interface

+3.3V volt Electrical Power Interface						
Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Supply Current	Is		320	375	mA	1.2W max power over full range of voltage and temperature. See caution note below
Input Voltage	Vcc	3.13	3.3	3.47	V	Referenced to GND
Maximum Voltage	Vmax			4	V	
Surge Current	Isurge			30	mA	Hot plug above steady state current. See caution note below

Caution: Power consumption and surge current are higher than the specified values in the SFP MSA

Low-Speed Signals

MOD_DEF(1) (SCL) and MOD_DEF(2) (SDA), are open drain CMOS signals (see section VII, “Serial Communication Protocol”). Both MOD_DEF(1) and MOD_DEF(2) must be pulled up to host_Vcc.

Table 2. Low-speed signals, electronic characteristics

Low-Speed Signals, Electronic Characteristics					
Parameter	Symbol	Min	Max	Units	Notes/Conditions
SFP Output LOW	VOL	0	0.5	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector
SFP Output HIGH	VOH	host_Vcc - 0.5	host_Vcc + 0.3	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector
SFP Input LOW	VIL	0	0.8	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector
SFP Input HIGH	VIH	2	Vcc + 0.3	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector

High-Speed Electrical Interface

All high-speed signals are AC-coupled internally.

Table 3. High-speed electrical interface, transmission line-SFP

High-Speed Electrical Interface Transmission Line-SFP						
Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Line Frequency	fL		125		MHz	5-level encoding, per IEEE 802.3u
Tx Output Impedance	Zout,TX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz
Rx Input Impedance	Zin,RX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz

High-speed electrical interface, host-SFP

Table 4. High-speed electrical interface, host-SFP

High-Speed Electrical Interface, Host-SFP						
Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Single ended data input swing	Vinsing	250		1200	mV	Single ended
Single ended data output swing	Voutsing	350		800	mV	Single ended
Rise/Fall Time	Tr,Tf		175		psec	20%-80%
Tx Input Impedance	Zin		50		Ohm	Single ended
Rx Output Impedance	Zout		50		Ohm	Single ended

General Specifications

Table 5. General specifications

General						
Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Data Rate	BR	10		100	Mb/sec	IEEE802.3u
Cable Length	L			100	m	Category 5 UTP. BER <10-12

Notes:

1. Clock tolerance is +/- 50 ppm
2. By default, the XSUEXC-M1RN is a full duplex device in preferred master mode
3. Automatic crossover detection is enabled. External crossover cable is not required

Environmental Specifications

Table 6. Environmental specifications

Environmental Specifications						
Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Operating Temperature	Top	0		70	°C	Case temperature
Storage Temperature	Tsto	-40		85	°C	Ambient temperature

Mechanical Specifications

The host-side of the XSUEXC-MIRN conforms to the mechanical specifications outlined in the SFP MSA1. The front portion of the SFP (part extending beyond the face plate of the host) is larger to accommodate the RJ-45 connector.

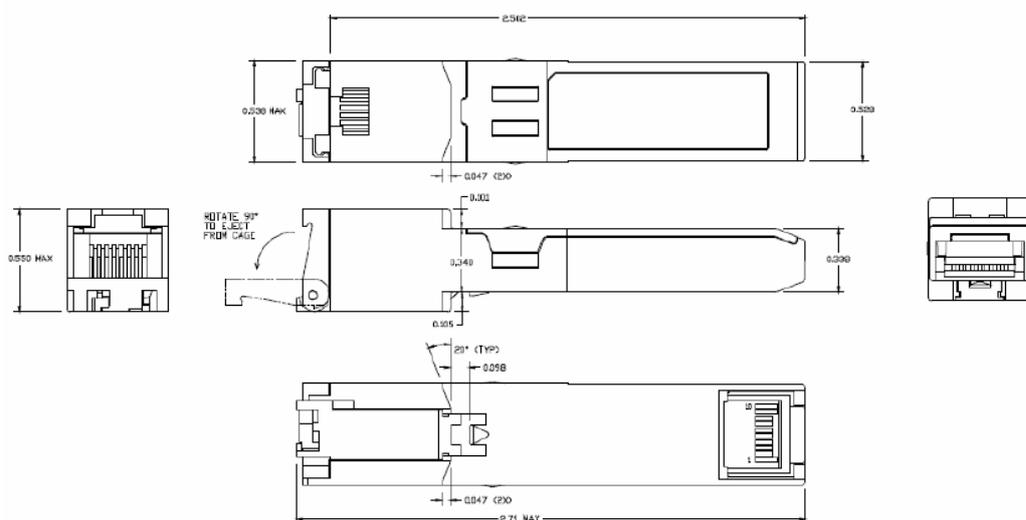


Figure 1. XSUEXC-MIRN mechanical dimensions

Ordering information

Part number	Operating Case temperature
XSUEFC-MIRN	10/100Mbps, Copper SFP with spring latch
XSUECC-MIRN	100Mbps only, Copper SFP with spring latch

E-mail: info@xenya.si

Web: <http://www.xenya.si>